

N-Channel MOSFET

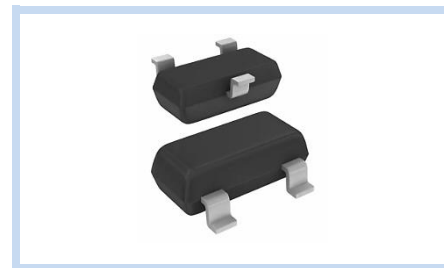
60V 0.15W SOT-523 ESD

MFT6NA115S523E

MERITEK

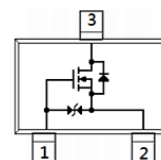
FEATURE

- $R_{DS(ON)}=3\Omega$, $V_{GS}=10V$
- $R_{DS(ON)}=4\Omega$, $V_{GS}=4.5V$
- ESD Protection Gate HBM 2KV
- Voltage Controlled Small Signal Switch
- High Saturation Current Capability
- Application: DC/DC Converter, Battery Switch



MECHANICAL DATA

- Case: SOT-523 Package
- Terminals: Solderable per MIL-STD-750, Method 2026

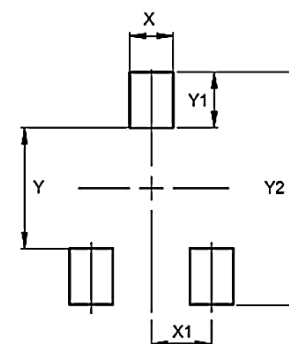
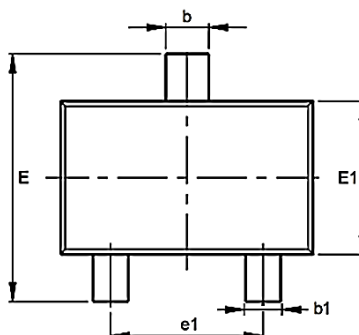
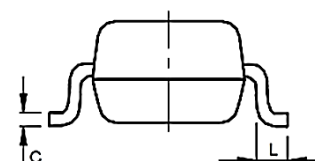
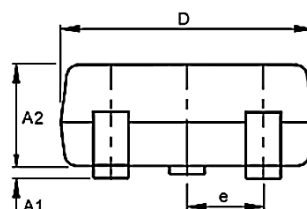


MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	115	mA
Power Dissipation	P_D	0.15	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	833	$^{\circ}C / W$
Junction Operating Temperature	T_J	150	$^{\circ}C$
Storage Temperature Range	T_{stg}	-55 to 150	$^{\circ}C$

DIMENSIONS

Item	Min (mm)	Max (mm)
A1	0.00	0.10
A2	0.70	0.80
b	0.25	0.35
b1	0.15	0.25
c	0.10	0.20
D	1.50	1.70
e	0.50 TYP	
e1	0.90	1.10
E	1.45	1.75
E1	0.70	0.90
L	0.26	0.46
X	0.5	
X1	0.5	
Y	0.64	
Y1	0.6	
Y2	2.04	



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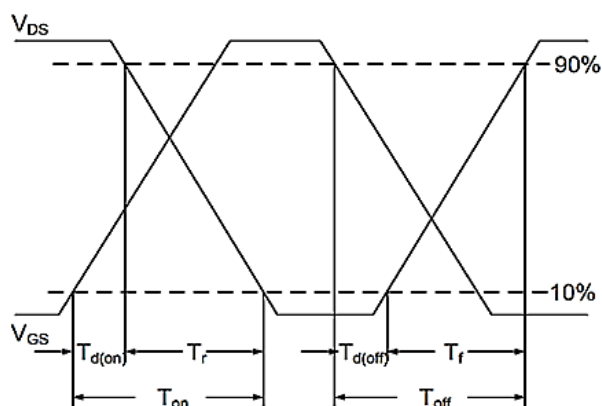
ELECTRICAL CHARACTERISTICS

Off Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	BV_{DSS}	60	--	--	V
Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	$V_{GS(th)}$	1.0	--	2.5	V
Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$	I_{GSS}	--	--	± 10	μA
Zero Gate Voltage Drain Current	$V_{DS}=60V, V_{GS}=0V$	I_{DSS}	--	--	1	μA
On Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=0.5A$	$R_{DS(on)}$	--	--	3	Ω
	$V_{GS}=4.5V, I_D=0.2A$		--	--	4	
Dynamic Characteristics	Conditions	Symbol	--	Typ.	Max	Unit
Input Capacitance	$V_{DS}=25V, V_{GS}=0V, F=1.0MHz$	C_{iss}	--	30	50	pF
Output Capacitance		C_{oss}	--	4.2	25	
Reverse Transfer Capacitance		C_{rss}	--	2.9	5	
Total Gate Charge	$V_{DS}=10V, V_{GS}=4.5V, I_D=0.25A$	Q_g	--	0.3	--	nC
Gate-Source Charge		Q_{gs}	--	0.2	--	
Gate-Drain Charge		Q_{gd}	--	0.08	--	
Turn-On Delay Time	$V_{DS}=30V, I_D=0.2A, V_{GS}=10V, R_G=25\Omega$	$T_{d(on)}$	--	3.9	--	nS
Rise Time		T_r	--	3.4	--	
Turn-Off Delay Time		$T_{d(off)}$	--	15.7	--	
Fall Time		T_f	--	9.9	--	
Drain-Source Body Diode	Conditions	Symbol	Min	Typ.	Max	Unit
Diode Forward Voltage	$I_S=0.2A, V_{GS}=0V$	V_{SD}	--	--	1.3	V

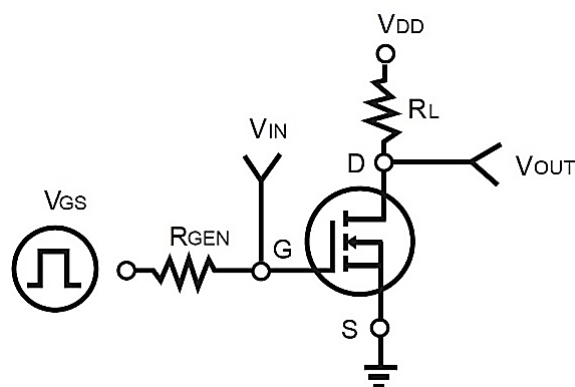
Note:

1. $T_A = 25^\circ C$, unless otherwise noted
2. Pulse width $< 300\mu s$, Duty cycle $< 2\%$.

Switching Time Waveform

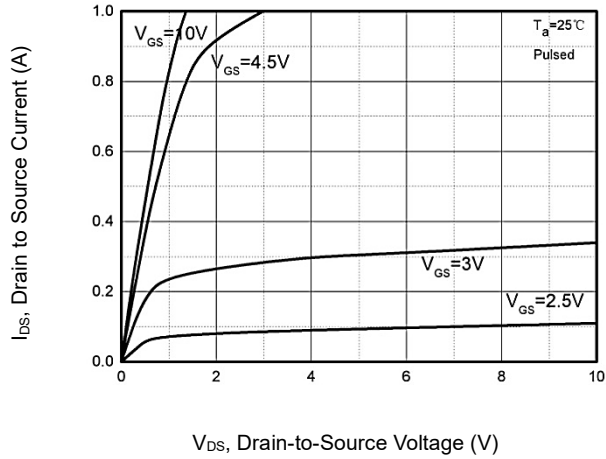


Switching Test Circuit

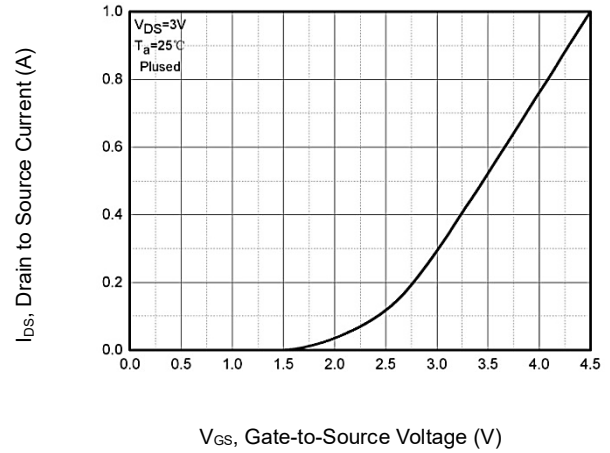


CHARACTERISTIC CURVES

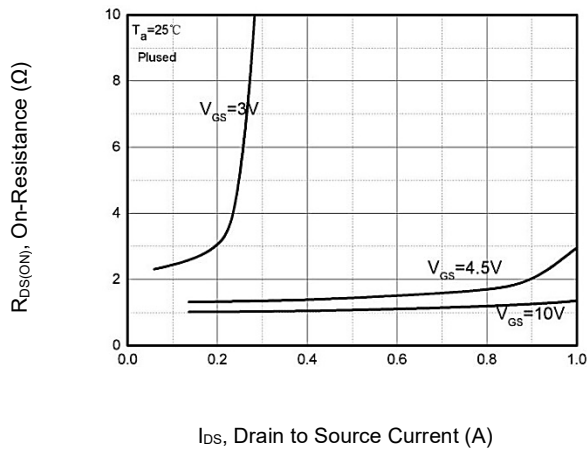
On Region Characteristics



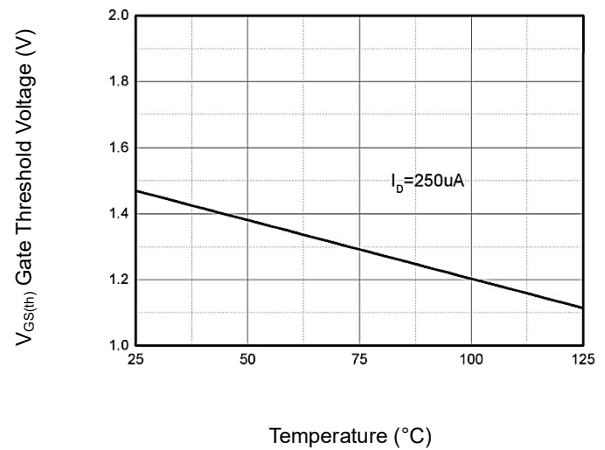
Transfer Characteristics



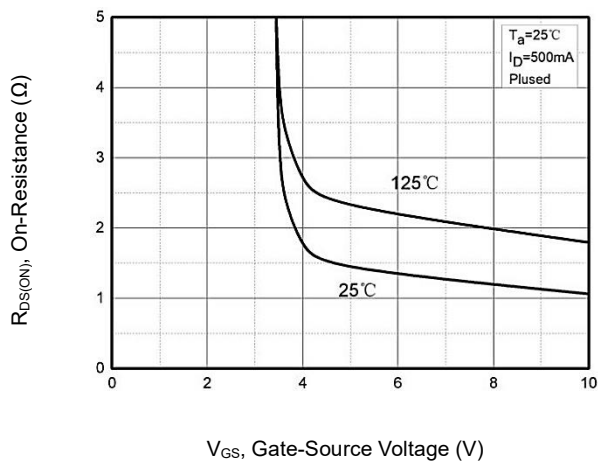
On-Resistance vs. Drain Current



Threshold Voltage Variance



On-Resistance Variation with Vgs



Body Diode Characteristics

